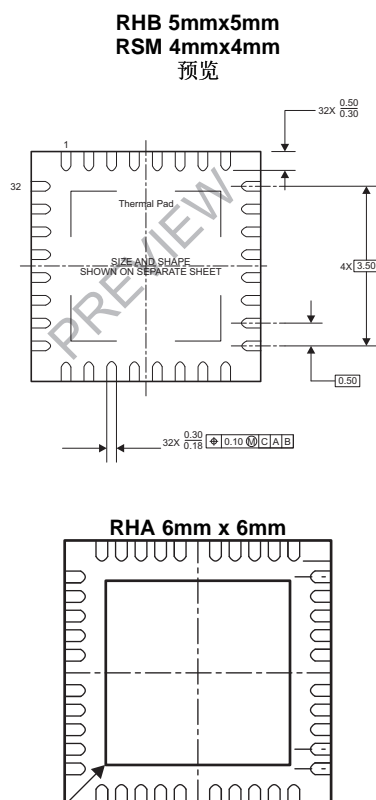


通过 I2C 兼容接口提供人机接口器件 (HID) 的低压 8x16 键盘扫描器

查询样品: TCA8424

特性

- 工作电源电压范围为 **1.65V 至 3.6V**
 - 支持高达 **1MHz** 的 **FM+I2C** 运行
 - 能够支持高达 **128 (8x16)** 键位扫描
 - 内部加电复位
 - 开漏低电平有效 **INT** 输出
 - 在串行时钟/串行数据 (**SCL/SDA**) 输入上的噪声滤波器
 - 开漏输出能够吸收高达 **12mA** 的发光二极管 (**LED**) 电流
 - 固化在器件程序代码中的 **HID** 和报告 (**REPORT**) 描述符
 - 可提供预先编程的键盘映射
 - 可通过 **I2C** 标准接口对每个 **HID** 进行软件复位
 - 内部上拉电阻器使执行简便且无需外部组件
 - 支持通过 **I2C** 命令进行控制的 **HID**
 - 复位
 - 获得报告
 - 设定报告
 - 设定电源
 - 固定长度 **8** 字节输入 (**INPUT**) 报告可检测除辅助修改键 (**CTRL**, **ALT**, **SHIFT** 键) 之外高达 **6** 个键位的同时按压。
 - 键位按压和释放时生成的 **INPUT** 报告
 - 锁断性能超过 **100mA** (符合 **JESD 78**, II 类规范的要求)
 - 静电放电 (**ESD**) 保护性能超过 **JESD 22** 规范要求
 - **1000V** 人体模型 (**A114-A**)
- RHB 5mmx5mm**
RSM 4mmx4mm
预览
- RHA 6mm x 6mm**



说明

这个 128 键位扫描器件专门针对操作系统为 Windows 8 的终端设备。此器件与由已定义的 I2C 技术规范（1.0 版本）（由微软 (Microsoft) 定义）控制的 HID 完全兼容。此 HID 和报告描述符被固化在器件程序代码中，这样就无需在生产时对它们进行编程。此器件还有一个预先编程的键盘映射，此映射与大多数标准笔记本/台式机键盘兼容。然而，也可以提供没有预先设定键盘的器件，这样在生产时可将任何键盘映射写入此器件。

此器件生成标准 8 字节长度的 INPUT 报告，其中 1st 字节为辅助修改键字节。在键盘映射被写入到器件后，它根据辅助修改键的使用代码来自动识别它们的行/列位置。它能够检测和报告与 8 个辅助修改键组合在一起的多达 6 个同时键位按压。它在每次键位按压和键位释放时生成一个输入报告。

此器件还支持键盘上标配的 LED 指示器。不同的变量支持 2, 4 或 8 LED 输出。每个输出具有开漏架构并且能够吸收高达 12mA 的电流。如使用 I2C 标准的 HID 中所述, LED 由一个标准输出 (OUTPUT) 报告控制。



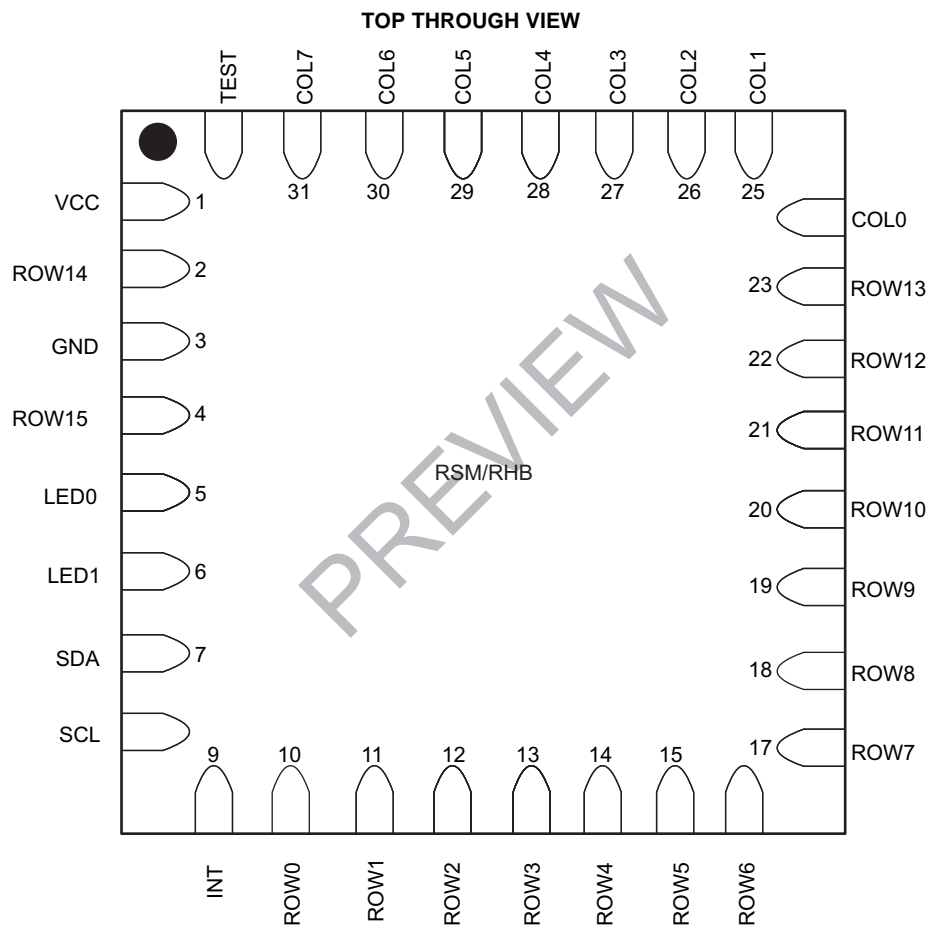
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

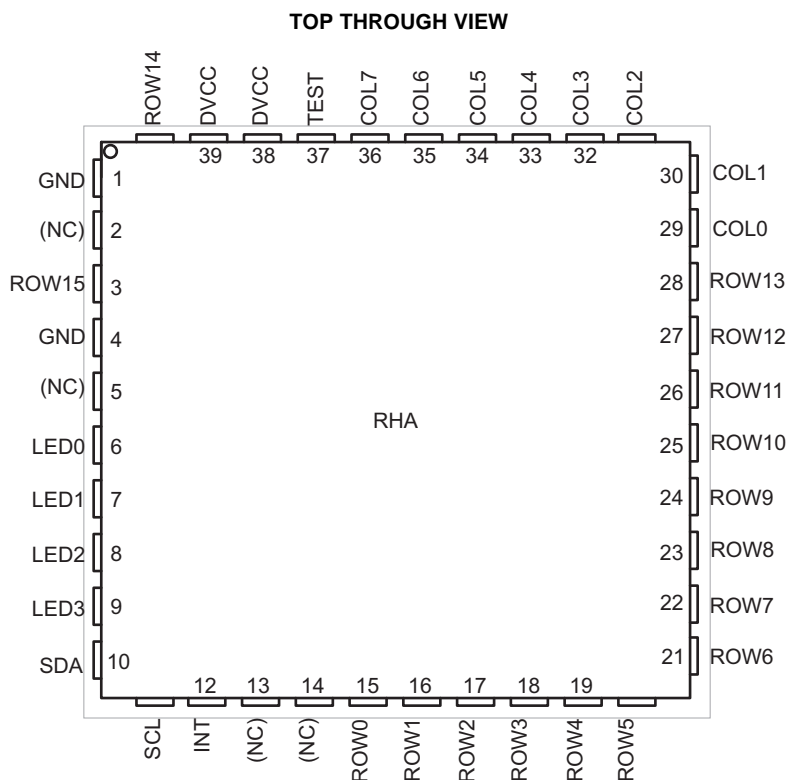
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of the Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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English Data Sheet: [SCDS341](#)



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.



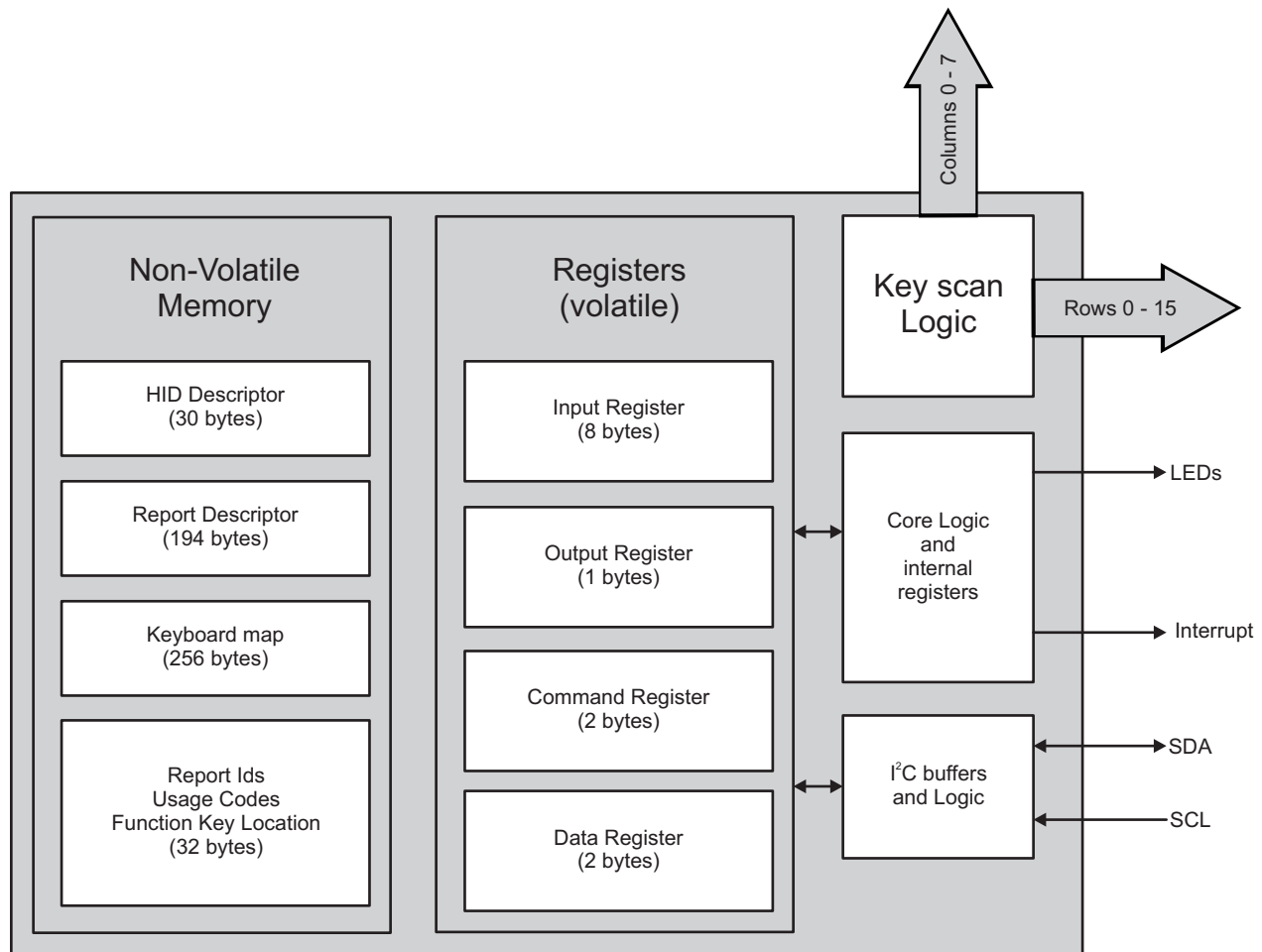


PIN FUNCTIONS

| NAME | TYPE | FUNCTION |
|-------------------------|--------|---|
| VCC | Power | Supply voltage for the device. The I2C bus should be pulled up to this rail. The key matrix IO voltages are also referenced to this supply voltage. |
| COL0–COL7 | Input | COLs of the key matrix |
| ROW0–ROW15 | Output | ROW of key matrix |
| LED0–LED7 | Output | Open drain output for driving LEDs |
| TEST | Input | High voltage input used to program the internal memory. To be grounded in application. ⁽¹⁾ |
| GND | Power | Ground |
| $\overline{\text{INT}}$ | output | Active-low interrupt output. Connect to V_{CC} through a pull-up resistor. |
| SCL | Input | Serial clock bus. Connect to V_{CC} through a pull-up resistor. |
| SDA | I/O | Serial data bus. Connect to V_{CC} through a pull-up resistor. |

(1) TEST pin must be grounded in application to ensure proper operation of device.

SIMPLIFIED BLOCK DIAGRAM



I²C INTERFACE

The bidirectional I²C bus consists of the serial clock (SCL) and serial data (SDA) lines. Both lines must be connected to V_{CC} through a pull-up resistor. Data transfer may be initiated only when the bus is not busy.

I²C communication with this device is initiated by a master sending a Start condition, a high-to-low transition on the SDA input/output, while the SCL input is high. After the Start condition, the device address byte is sent, most significant bit (MSB) first, including the data direction bit (R/W).

After receiving the valid address byte, this device responds with an acknowledge (ACK), a low on the SDA input/output during the high of the ACK-related clock pulse.

On the I²C bus, only one data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the high pulse of the clock period, as changes in the data line at this time are interpreted as control commands (Start or Stop). A Stop condition, a low-to-high transition on the SDA input/output while the SCL input is high, is sent by the master.

Any number of data bytes can be transferred from the transmitter to receiver between the Start and the Stop conditions. Each byte of eight bits is followed by one ACK bit. The transmitter must release the SDA line before the receiver can send an ACK bit. The device that acknowledges must pull down the SDA line during the ACK clock pulse, so that the SDA line is stable low during the high pulse of the ACK-related clock period. When a slave receiver is addressed, it must generate an ACK after each byte is received. Similarly, the master must generate an ACK after each byte that it receives from the slave transmitter. Setup and hold times must be met to ensure proper operation.

A master receiver signals an end of data to the slave transmitter by not generating an acknowledge (NACK) after the last byte has been clocked out of the slave. This is done by the master receiver by holding the SDA line high. In this event, the transmitter must release the data line to enable the master to generate a Stop condition.

NOTE

Any communication to another device on the same I2C BUS must be terminated by a stop condition before communicating to the TCA8424. Any glitches below $0.7 \times V_{CC}$ on the SCL or SDA line should be less than 50 ns as per the I2C specification.

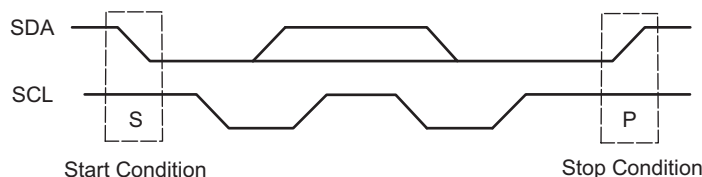


Figure 1. Definition of Start and Stop Conditions

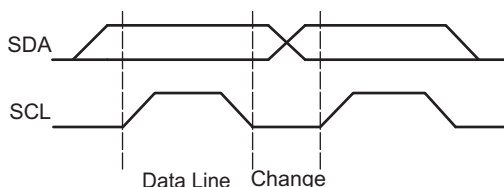


Figure 2. Bit Transfer

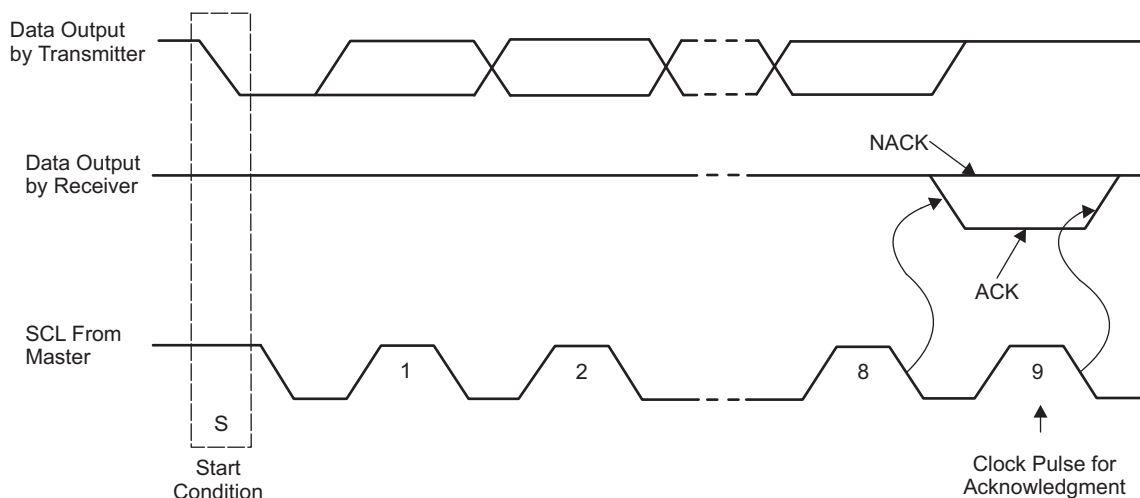


Figure 3. Acknowledgment on I²C Bus

DEVICE I²C ADDRESS

The address of the device is shown below:

Table 1. Address Reference

| SLAVE ADDRESS | | | | | | | | I2C BUS SLAVE ADDRESS |
|---------------|----|----|----|----|----|----|-------|-----------------------|
| B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 | |
| 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 (W) | 134 (decimal), 76(h) |
| 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1 (R) | 135 (decimal), 77(h) |

The last bit of the slave address defines the operation (read or write) to be performed. A high (1) selects a read operation. While a low (0) selects a write operation.

Other I2C address options are available. Please contact your local TI sales person for devices with alternate I2C address.

REGISTER ADDRESS BYTE

Following the successful acknowledgment of the I2C address byte, the bus master sends two register address bytes indicating the address of the register on which the read or write operation needs to be performed. This register address is stored in an internal register and used by the device for subsequent read/write to the device. This is explained more in detail in subsequent sections of the DS.

Other I2C address options are available. Contact your local TI sales person for devices with alternate I2C address.

Table 2. Register Map

| | REGISTER ADDRESS (Hex) | DESCRIPTION | POWER UP DEFAULT |
|--------------------------------------|---------------------------|--|----------------------------------|
| HID descriptor | 0000h-001Dh | HID descriptor | See section on HID descriptor |
| Report Descriptor | 0030h-00F1h | Report descriptor | See section on Report descriptor |
| Keyboard Map | 0100h-01FFh | keyboard Map | see section on Keyboard map |
| Function Key location ⁽¹⁾ | 0201h | Function Key location on Keyboard Map ⁽²⁾ | 0 |
| Default Report ID | 0202h | Default Report ID | 1 |
| Report ID1 | 0203h | Report ID1 | 2 |
| Report ID2 | 0204h | Report ID2 | 3 |
| Report ID3 | 0205h | Report ID3 | 4 |
| Report ID4 | 0206h | Report ID4 | 5 |
| Report ID1 usage IDs | 0207h-020Eh | Usage IDs associated with ReportID1 | A7 – AE |
| Report ID2 usage IDs | 020Fh-0216h | Usage IDs associated with ReportID2 | AF – B6 |
| Report ID3 usage IDs | 0217h-021Eh | Usage IDs associated with ReportID3 | B7 – BA |
| Report ID4 usage IDs | 021Fh-0226h | Usage IDs associated with ReportID4 | BB – BE |
| Input report | 0400h | input report length (LSB) | 00h |
| | 0401h | input report length (MSB) | 00h |
| | 0402h | Report ID | A2 |
| | 0403h | modifier byte | 00h |
| | 0404h | reserved | reserved |
| | 0405h | usage code 1 | 00h |
| | 0406h | usage code 2 | 00h |
| | 0407h | usage code 3 | 00h |
| | 0408h | usage code 4 | 00h |
| | 0409h | usage code 5 | 00h |
| | 040Ah | usage code 6 | 00h |
| Output report | 0500h | LED status | 00h |
| Command register | 0600h | HID over I2C Command low byte | 00h |
| | 0601h | HID over I2C Command high byte | 00h |
| Data register | 0700-070Ah | Data for HID over I2C command | 00h |

(1) Function Key Usage ID in keyboard map must be non-zero

(2) Column/Row intersection of function key. i.e. col3 row4 intersection would read 34h

Table 2. Register Map (continued)

| | REGISTER ADDRESS (Hex) | DESCRIPTION | POWER UP DEFAULT |
|--|---------------------------|---|------------------|
| HID Descriptor ⁽³⁾ (0000h-001Dh) | 0000h ⁽³⁾ | HID Descriptor length | 40h |
| | 0001h | | 41h |
| | 0002h | BCD version | 42h |
| | 0003h | | 43h |
| | 0004h | Report descriptor length | 44h |
| | 0005h | | 45h |
| | 0006h | Report Descriptor Register address | 46h |
| | 0007h | | 47h |
| | 0008h | Input register address | 48h |
| | 0009h | | 49h |
| | 000Ah | max input report length (including 2 bytes length field) | 4Ah |
| | 000Bh | | 4Bh |
| | 000Ch | Output register address | 4Ch |
| | 000Dh | | 4Dh |
| | 000Eh | max output report length (including 2 bytes length field) | 4Eh |
| | 000Fh | | 4Fh |
| | 0010h | Command register address | 50h |
| | 0011h | | 51h |
| | 0012h | data register address | 52h |
| | 0013h | | 53h |
| | 0014h | Vendor ID | 54h |
| | 0015h | | 55h |
| | 0016h | Product ID | 56h |
| | 0017h | | 57h |
| | 0018h | Version ID | 58h |
| | 0019h | | 59h |
| | 001Ah | Reserved per HID over I2C spec v0.91 | 5Ah |
| | 001Bh | | 5Bh |
| | 001Ch | | 5Ch |
| | 001Dh | | 5Dh |
| | | | 5Eh |

(3) The Hid descriptor start address must be 0000h

HID DESCRIPTOR RETRIEVAL

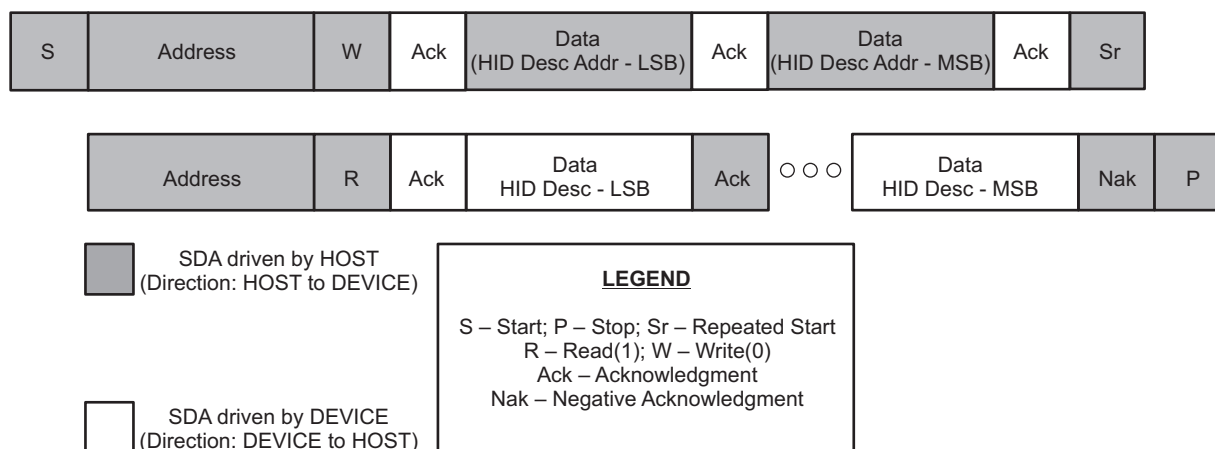


Figure 4. Typical Retrieval of the HID Descriptor

Figure 4 shows the typical retrieval of the HID descriptor. This is the most common way the HID descriptor is retrieved. However, the TCA8424 allows partial retrieval of the descriptor as described in the HID over I2C spec rev 1.0.

Table 3. Report Descriptor

| | Register Address | Power up Default |
|---|------------------|------------------|
| Report ⁽¹⁾ descriptor (0030h-00F1h) | 30 | 5F |
| | 31 | 60 |
| | 32 | 61 |
| | 33 | 62 |
| | 34 | 63 |
| | 35 | 64 |
| | 36 | 65 |
| | 37 | 66 |
| | 38 | 67 |
| | 39 | 68 |
| | 3A | 69 |
| | 3B | 6A |
| | 3C | 6B |
| | 3D | 6C |
| | 3E | 6D |
| | 3F | 6E |
| | 40 | 6F |
| | 41 | 70 |
| | 42 | 71 |
| | 43 | 72 |
| | 44 | 73 |
| | 45 | 74 |
| | 46 | 75 |
| | 47 | 76 |
| | 48 | 77 |

(1) Report descriptor contents may vary depending on version of device. Please contact TI for device for different Report Descriptor contents

Table 3. Report Descriptor (continued)

| | Register Address | Power up Default |
|------------------------------------|------------------|------------------|
| Report descriptor (0030h-00F1h) | 49 | 78 |
| | 4A | 79 |
| | 4B | 7A |
| | 4C | 7B |
| | 4D | 7C |
| | 4E | 7D |
| | 4F | 7E |
| | 50 | 7F |
| | 51 | 80 |
| | 52 | 81 |
| | 53 | 82 |
| | 54 | 83 |
| | 55 | 84 |
| | 56 | 85 |
| | 57 | 86 |
| | 58 | 87 |
| | 59 | 88 |
| | 5A | 89 |
| | 5B | 8A |
| | 5C | 8B |
| | 5D | 8C |
| | 5E | 8D |
| | 5F | 8E |
| | 60 | 8F |
| | 61 | 90 |
| | 62 | 91 |
| | 63 | 92 |
| | 64 | 93 |
| | 65 | 94 |
| | 66 | 95 |
| | 67 | 96 |
| | 68 | 97 |
| | 69 | 98 |
| | 6A | 99 |
| | 6B | 9A |
| | 6C | 9B |
| | 6D | 9C |
| | 6E | 9D |
| | 6F | 9E |
| | 70 | 9F |
| | 71 | A0 |
| | 72 | A1 |
| | 73 | A2 |
| | 74 | A3 |
| | 75 | A4 |
| | 76 | A5 |

Table 3. Report Descriptor (continued)

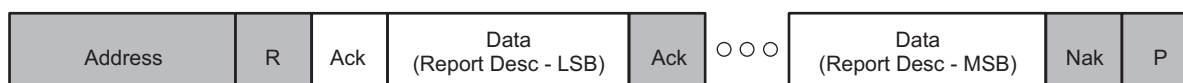
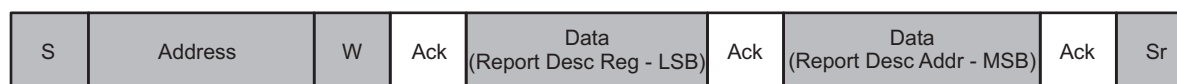
| | Register Address | Power up Default |
|------------------------------------|------------------|------------------|
| Report descriptor (0030h-00F1h) | 77 | A6 |
| | 78 | A7 |
| | 79 | A8 |
| | 7A | A9 |
| | 7B | AA |
| | 7C | AB |
| | 7D | AC |
| | 7E | AD |
| | 7F | AE |
| | 80 | AF |
| | 81 | B0 |
| | 82 | B1 |
| | 83 | B2 |
| | 84 | B3 |
| | 85 | B4 |
| | 86 | B5 |
| | 87 | B6 |
| | 88 | B7 |
| | 89 | B8 |
| | 8A | B9 |
| | 8B | BA |
| | 8C | BB |
| | 8D | BC |
| | 8E | BD |
| | 8F | BE |
| | 90 | BF |
| | 91 | C0 |
| | 92 | C1 |
| | 93 | C2 |
| | 94 | C3 |
| | 95 | C4 |
| | 96 | C5 |
| | 97 | C6 |
| | 98 | C7 |
| | 99 | C8 |
| | 9A | C9 |
| | 9B | CA |
| | 9C | CB |
| | 9D | CC |
| | 9E | CD |
| | 9F | CE |
| | A0 | CF |
| | A1 | D0 |
| | A2 | D1 |
| | A3 | D2 |
| | A4 | D3 |
| | A5 | D4 |


Table 3. Report Descriptor (continued)

| | Register Address | Power up Default |
|------------------------------------|------------------|------------------|
| Report descriptor (0030h-00F1h) | A6 | D5 |
| | A7 | D6 |
| | A8 | D7 |
| | A9 | D8 |
| | AA | D9 |
| | AB | DA |
| | AC | DB |
| | AD | DC |
| | AE | DD |
| | AF | DE |
| | B0 | DF |
| | B1 | E0 |
| | B2 | E1 |
| | B3 | E2 |
| | B4 | E3 |
| | B5 | E4 |
| | B6 | E5 |
| | B7 | E6 |
| | B8 | E7 |
| | B9 | E8 |
| | BA | E9 |
| | BB | EA |
| | BC | EB |
| | BD | EC |
| | BE | ED |
| | BF | EE |
| | C0 | EF |
| | C1 | F0 |
| | C2 | F1 |
| | C3 | F2 |
| | C4 | F3 |
| | C5 | F4 |
| | C6 | F5 |
| | C7 | F6 |
| | C8 | F7 |
| | C9 | F8 |
| | CA | F9 |
| | CB | FA |
| | CC | FB |
| | CD | FC |
| | CE | FD |
| | CF | FE |
| | D0 | FF |
| | D1 | 0 |
| | D2 | 1 |
| | D3 | 2 |
| | D4 | 3 |

Table 3. Report Descriptor (continued)

| | Register Address | Power up Default |
|------------------------------------|------------------|------------------|
| Report descriptor (0030h-00F1h) | D5 | 4 |
| | D6 | 5 |
| | D7 | 6 |
| | D8 | 7 |
| | D9 | 8 |
| | DA | 9 |
| | DB | 0A |
| | DC | 0B |
| | DD | 0C |
| | DE | 0D |
| | DF | 0E |
| | E0 | 0F |
| | E1 | 10 |
| | E2 | 11 |
| | E3 | 12 |
| | E4 | 13 |
| | E5 | 14 |
| | E6 | 15 |
| | E7 | 16 |
| | E8 | 17 |
| | E9 | 18 |
| | EA | 19 |
| | EB | 1A |
| | EC | 1B |
| | ED | 1C |
| | EE | 1D |
| | EF | 1E |
| | F0 | 1F |

REPORT DESCRIPTOR RETREIVAL

 SDA driven by HOST
(Direction: HOST to DEVICE)

 SDA driven by DEVICE
(Direction: DEVICE to HOST)

LEGEND

S – Start; P – Stop; Sr – Repeated Start
 R – Read(1); W – Write(0)
 Ack – Acknowledgment
 Nak – Negative Acknowledgment

INPUT REPORT

Input reports are used to communicate key presses and releases to the host controller. The TCA8424 is capable of communicating up to six simultaneous key presses and up to eight modifier keys. The standard modifier keys recognized by the TCA8424 are (Usage ID based on HID usage tables ver 1.11). The usage ID for each key is stored in the keyboard map section of NV memory.

- Left Ctrl (Usage ID – E0)
- Left shift (Usage ID – E1)
- Left Alt (Usage ID – E2)
- Left GUI (Usage ID – E3)
- Right Ctrl (Usage ID – E4)
- Right shift (Usage ID – E5)
- Right Alt (Usage ID – E6)
- Right GUI (Usage ID – E7)

Below is that format of a standard input report. The first two bytes are data length field indicating the length of input report.

| Byte | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|------|---------------|----------|------------|-----------|---------|---------|-----------|----------|
| 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 1 |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 2 | Report ID | | | | | | | |
| 3 | RightGUI | RightAlt | RightShift | RightCtrl | LeftGUI | LeftAlt | LeftShift | LeftCtrl |
| 4 | Reserved | | | | | | | |
| 5 | Key1 Usage ID | | | | | | | |
| 6 | Key2 Usage ID | | | | | | | |
| 7 | Key3 Usage ID | | | | | | | |
| 8 | Key4 Usage ID | | | | | | | |
| 9 | Key5 Usage ID | | | | | | | |
| 10 | Key6 Usage ID | | | | | | | |

An input report is generated for every key press and also on every key release. If no keys are pressed after a key release then the report contains all zeroes except for the Data length field (first two bytes) and the Report ID. Input reports are also generated if only modifier keys are pressed (not accompanied by any other key). The data length field (first two bytes) for a standard key press is always 11.

SPECIAL MODIFIER (Fn key) AND ALTERNATE REPORT IDs

Other than the standard modifiers, the TCA8424 also supports one special modifier such as the function (FN) key. This operates different from the other modifier keys in that, it is not represented in the modifier byte of the input report. The TCA8424 only supports a single key press in combination with the FN key.

When the FN key is pressed the TCA8424 generates a default input report indicating that all keys have been released. A FN key release will generate an input report with the current Report ID and cleared usage codes. The TCA8424 only supports a single key press in combination with the FN key. Any key pressed after the FN key that does not have a non-zero Usage ID will be ignored. Once the FN key is pressed and a key that has an Usage ID in the alternate keyboard map has been pressed, additional key presses will be ignored until either the FN key is released or the second key that had an Usage ID in the alternate keyboard map is released.

In addition to standard function keys, many keyboards support special functions such as volume up, volume down, skip track, previous track etc. Report IDs are used as a way for the host processor to identify whether the usage ID corresponds to a standard function key or a special function key. The TCA8424 supports Five different report IDs. **Report IDs must be non-zero.**

1. Default Report ID – located at address 0202h. This ID is populated in the input report when there is a normal key press or a regular function key.
2. Report ID 1 – located at address 0203h. This ID is populated in the report when the Usage ID of the key press detected by the TCA8424 corresponds to a usage ID located in the memory range (0207h-020Eh)
3. Report ID 2 – located at address 0204h. This ID is populated in the report when the Usage ID of the key

press detected by the TCA8424 corresponds to a usage ID located in the memory range (020Fh-0216h)

4. Report ID 3 – located at address 0204h. This ID is populated in the report when the Usage ID of the key press detected by the TCA8424 corresponds to a usage ID located in the memory range (0217h-021Eh)
5. Report ID 4 – located at address 0204h. This ID is populated in the report when the Usage ID of the key press detected by the TCA8424 corresponds to a usage ID located in the memory range (021Fh-0226h)

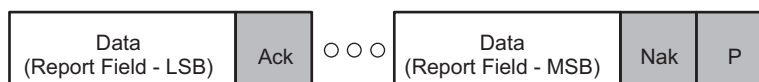
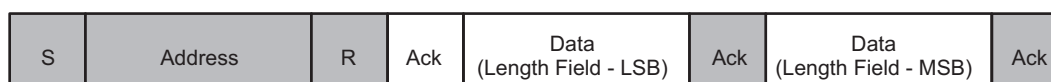
As can be inferred from the above description, whenever a key press is detected, the TCA8424 looks up the usage ID from the alternate keyboard map and then compares this usage ID with the usage IDs corresponding to Report ID 1, Report ID 2, Report ID 3, and Report ID 4. If there is a match, then corresponding report ID is populated in the special input report. If not the default input report is used with the default Report ID. ⁽¹⁾


Below is the format of the special input report. The format is similar to the bit field representation used to represent the modifier byte in the standard input report. Usage ID byte location 0 will correspond to the first Usage ID in memory for the respective Report ID ⁽²⁾ and descend with Usage ID byte location 7 corresponding to the last Usage ID in memory. ⁽²⁾


Table 4. Special Input Report

| Byte | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|----------------------------|----------------------------|--------------------------------|
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 2 | Report ID | | | | | | | |
| 3 | Usage ID byte location 7 | Usage ID byte location 6 | Usage ID byte location 5 | Usage ID byte location 4 | Usage ID byte location 3 | Usage ID byte location2 | Usage ID byte location1 | Usage ID byte location 0 |

- (1) The last 5 key Usage IDs in the input report and the modifier byte will always read 00h when the function key is pressed in addition to another key.
- (2) For Report ID1: Usage ID byte location 0 corresponds to memory location 0207h. Usage ID byte location 7 corresponds to memory location 020Eh.



 SDA driven by HOST
(Direction: HOST to DEVICE)

 SDA driven by DEVICE
(Direction: DEVICE to HOST)

LEGEND

S – Start; P – Stop; Sr – Repeated Start
R – Read(1); W – Write(0)
Ack – Acknowledgment
Nak – Negative Acknowledgment

Figure 5. Input Report Retrieval

It is important to note that, unlike retrieval of other reports, where the first I2C transaction is a write, in the case of input report the first transaction itself is a read operation as indicated by Bit 8 of the I2C address.

OUTPUT REPORT

Output reports are used by the host to turn ON/OFF any indicator LEDs (caps lock, num lock etc.) on the keyboard. The TCA8424 can support from 2 to 4 LED indicators depending on the version of the device chosen. The output reports are single byte reports (8-bit) where each bit indicates the status of the corresponding LED. A '1' indicates that the LED is turned on where as a '0' turns off the LED. Below is the format of the output report received from the host. Just as in the case of the input report the first two bytes indicate the length of the output report.

| Byte | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|------|----------|----------|----------|----------|-------|-------|-------|-------|
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 2 | Reserved | Reserved | Reserved | Reserved | LED3 | LED2 | LED1 | LED0 |

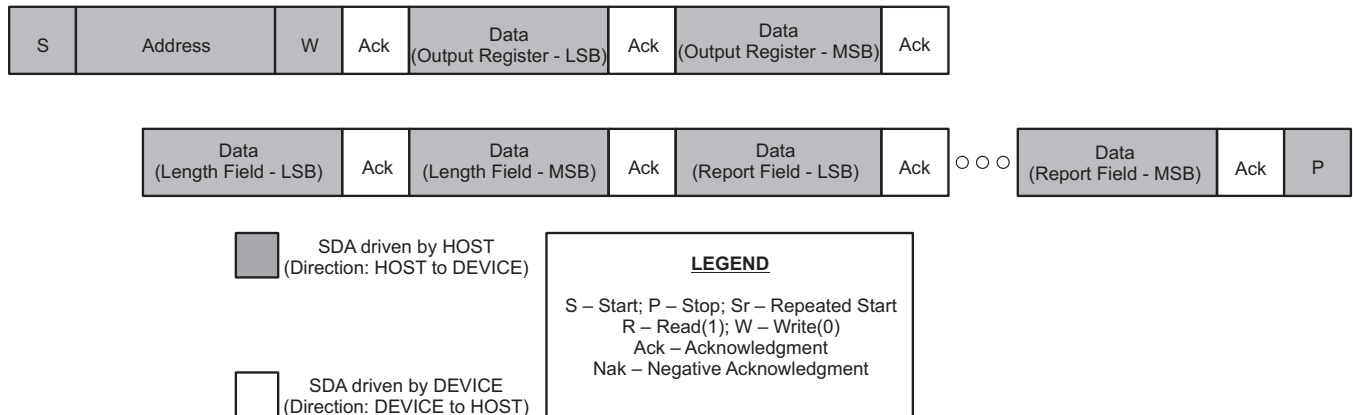


Figure 6. Output Report Retrieval

COMMAND and DATA REGISTER

The HID over I2C spec requires that all devices respond to certain commands. The commands are issued to the command register. The command is an opcode as defined by the HID over I2C spec. The operand for the command goes to the data register. Below is a list of commands supported by the TCA8424.

| Op Code | Command Name | Effect on Device |
|---------|--------------|--|
| 0001b | RESET | Device is reset and all registers are returned to default value. This command has the same effect on the device as a power on reset. |
| 0010b | GET_REPORT | Most recent input report is transferred to Data Register |
| 0011b | SET_REPORT | Data register contents are used to turn on/off LED. |
| 1000b | SET_POWER | All LEDs are turned off and device is in lowest current mode (will still detect key presses) |

The I2C transactions used to issue these commands are exactly as described in the HID over I2C standard.

RESET

After receiving the RESET command, the device will go through a full power on reset and all registers are loaded with their default values. The TCA8424 takes ~600µs to reset and during this time all I2C traffic will be ignored by the device. After coming out of reset, the data length field in the input report is populated with 0000h and the INT signal is asserted.

GET_REPORT

The GET_REPORT command will retrieve the current input report from the device but will not clear the interrupt asserted from a key press or release.

SET_REPORT

The SET_REPORT command is used to set the contents of the output report. The Data shall be packaged with the length field as 0x0003, and the third byte shall describe the LED outputs as defined in the report descriptor.

SET_POWER

The SET_POWER=SLEEP command will turn off all the LED outputs and clear the input report including report ID and length field. If a key is pressed when SET_POWER=SLEEP command is received, keyscan will stop when the command is received. TCA8424 will wait for all keys to be released before any subsequent key press will assert an interrupt. If a key is pressed and not released while device is asleep and the SET_POWER=WAKE command is received, the key scanner will start and assert an interrupt that a key has been pressed. The SET_POWER=WAKE command is received the LED outputs will be returned to the state they were before the SET_POWER=SLEEP was received. If a command to change the output report is received during sleep, the LED status will indicate that of the last output report received upon SET_POWER=WAKE.

If keys are pressed while the device is entering sleep mode, a read of the input report or use of the GET_REPORT command before all keys are released, may not reflect the current state of the keyboard. Any key presses that happen after all keys are released will populate the input report and assert INT.

KEYBOARD MAP

The Non volatile memory contains a section that contains the keyboard map. Each byte location in the keyboard map, is mapped to a specific row column intersection on the key matrix, and contains the usage ID of the key located in that row column intersection. The keyboard map consists of two sections. Each row column intersection is mapped to one location in each section. The primary section contains the usage ID of the key and the alternate section contains the alternate usage ID of the key that will be reported when the special modifier (FN) is used. Only keys with non-zero usage codes will be recognized, **including the function key**.

The device is available with some pre defined keyboard maps. It is also available with the keyboard map not programmed so that the end user may program the keyboard map based on the keyboard being used. Alternately you may contact TI for custom variations of the part with different keyboard maps programmed by special request.

The table below illustrates the column-row intersections and the memory locations they are mapped to.

| KEYBOARD MAP (PRIMARY) | | | | | | | | | KEYBOARD MAP (SECONDARY) | | | | | | | | |
|------------------------|----|----|----|----|----|----|----|----|--------------------------|----|----|----|----|----|----|----|----|
| | C0 | C1 | C2 | C3 | C4 | C5 | C6 | C7 | | C0 | C1 | C2 | C3 | C4 | C5 | C6 | C7 |
| R0 | A1 | B1 | C1 | D1 | E1 | F1 | 81 | 91 | R0 | A1 | B1 | C1 | D1 | E1 | F1 | 81 | 91 |
| R1 | A2 | B2 | C2 | D2 | E2 | F2 | 82 | 92 | R1 | A2 | B2 | C2 | D2 | E2 | F2 | 82 | 92 |
| R2 | A3 | B3 | C3 | D3 | E3 | F3 | 83 | 93 | R2 | A3 | B3 | C3 | D3 | E3 | F3 | 83 | 93 |
| R3 | A4 | B4 | C4 | D4 | E4 | F4 | 84 | 94 | R3 | A4 | B4 | C4 | D4 | E4 | F4 | 84 | 94 |
| R4 | A5 | B5 | C5 | D5 | E5 | F5 | 85 | 95 | R4 | A5 | B5 | C5 | D5 | E5 | F5 | 85 | 95 |
| R5 | A6 | B6 | C6 | D6 | E6 | F6 | 86 | 96 | R5 | A6 | B6 | C6 | D6 | E6 | F6 | 86 | 96 |
| R6 | A7 | B7 | C7 | D7 | E7 | F7 | 87 | 97 | R6 | A7 | B7 | C7 | D7 | E7 | F7 | 87 | 97 |
| R7 | A8 | B8 | C8 | D8 | E8 | F8 | 88 | 98 | R7 | A8 | B8 | C8 | D8 | E8 | F8 | 88 | 98 |
| R8 | A9 | B9 | C9 | D9 | E9 | F9 | 89 | 99 | R8 | A9 | B9 | C9 | D9 | E9 | F9 | 89 | 99 |
| R9 | AA | BA | CA | DA | EA | FA | 8A | 9A | R9 | AA | BA | CA | DA | EA | FA | 8A | 9A |
| R10 | AB | BB | CB | DB | EB | FB | 8B | 9B | R10 | AB | BB | CB | DB | EB | FB | 8B | 9B |
| R11 | AC | BC | CC | DC | EC | FC | 8C | 9C | R11 | AC | BC | CC | DC | EC | FC | 8C | 9C |
| R12 | AD | BD | CD | DD | ED | FD | 8D | 9D | R12 | AD | BD | CD | DD | ED | FD | 8D | 9D |
| R13 | AE | BE | CE | DE | EE | FE | 8E | 9E | R13 | AE | BE | CE | DE | EE | FE | 8E | 9E |
| R14 | AF | BF | CF | DF | EF | FF | 8F | 9F | R14 | AF | BF | CF | DF | EF | FF | 8F | 9F |
| R15 | B0 | C0 | D0 | E0 | F0 | 80 | 90 | A0 | R15 | B0 | C0 | D0 | E0 | F0 | 80 | 90 | A0 |

KEYSCAN LOGIC

Functional Overview

Upon power up or when coming out of RESET, the device initializes itself with all the registers having the power up default value. All the COLx pins are pulled up to V_{CC} by internal pull up resistors. All the ROWx pins are pulled low. The device is now in idle/standby mode (lowest power state). When any key is pressed, one of the COL pins gets connected to one of the ROW pins, thereby pulling down the corresponding COL pin. This initiates the keyscan.

When this occurs the internal oscillator turns on, and each ROWx pin goes low, one after the other, for approximately 800 μ S while the COLx inputs are sampled at each step. Then, for every key that is pressed, the corresponding usage ID from the keyboard map is registered. After approximately 25mS, the scan will repeat. If any previously pressed key is still pressed, then the corresponding code is written to the Input register. The scan continues to repeat as long as there are keys pressed. Now, when a previously pressed key is released another input report is generated with the keys that are still pressed, or if no keys are pressed, then an input report with all zero Usage codes is reported.

Once the input report has been populated into the input register, the \overline{INT} is asserted to indicate to the host that an input report is now available.

Interrupt (\overline{INT}) Output

An interrupt is generated when the device has an input report ready for the HOST to read. Resetting the interrupt is achieved by reading the INPUT Register. Using the GET_REPORT command will not clear the interrupt. The interrupt will clear after the 2nd read byte of the empty input report on reset. After reset, a default input report read will clear the input report after the last byte is read. If a special input report is read, the interrupt clears after the 4th byte is read.

The interrupt status is updated in the read mode at the acknowledge (ACK) or not acknowledge (NACK) bit following the rising edge of the SCL signal after the last byte of the input report has been read. The INPUT register will keep getting updated with the most recent key press reports even while the \overline{INT} signal stays asserted. In order avoid missing of key presses it is recommended that host processor respond to interrupt service request in <50ms (debounce time)

The \overline{INT} output has an open-drain structure and requires a pull-up resistor to V_{CC} . When the device comes out of power on reset, the \overline{INT} signal is asserted to indicate to the host that the device has come out of reset (as required by the HID over I2C). The value in the data length field of the input report is set to 0000h when the device comes out of POR (as required by the HID over I2C).

Power-On Reset

When power (from 0V) is applied to V_{CCP} , an internal power-on reset holds the TCA8424 in a reset condition until V_{CCP} has reached V_{POR} . At that time, the reset condition is released, and the TCA8424 registers and I2C state machine initialize to their default states. After that, V_{CCP} must be lowered to below V_{PORF} and back up to the operating voltage for a power-reset cycle.

- During power up, if V_{CCI} ramps before V_{CCP} , a power on reset event occurs and the I²C registers are reset.
- If V_{CCP} ramps up before V_{CCI} , then the device with reset as if $\overline{RESET} = 0$
- The device is reset regardless of which V_{CCx} ramps first.

Power-On Reset Requirements

In the event of a glitch or data corruption, TCA8424 can be reset to its default conditions by using the power-on reset feature. Power-on reset requires that the device go through a power cycle to be completely reset. This reset also happens when the device is powered on for the first time in an application.

The two types of power-on reset are shown in [Figure 7](#) and [Figure 8](#).

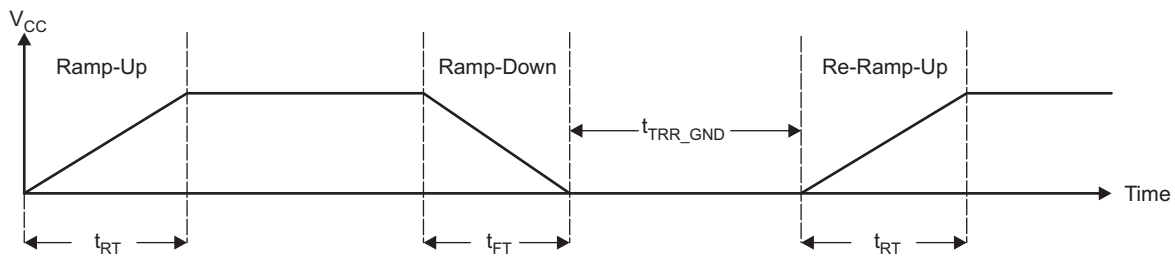


Figure 7. V_{CC} is Lowered Below 0.2 V or 0 V and Then Ramped Up to V_{CC}

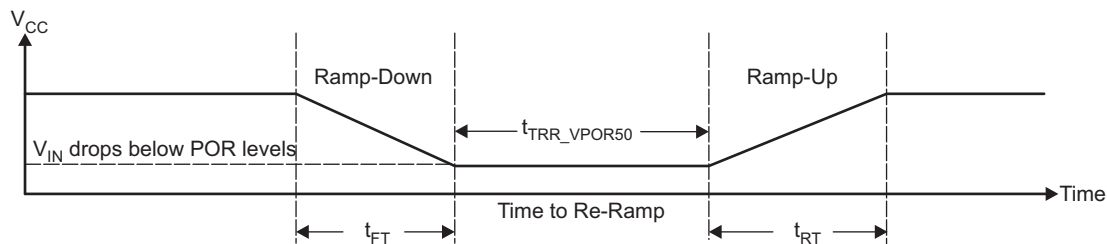


Figure 8. V_{CC} is Lowered Below the POR Threshold, Then Ramped Back Up to V_{CC}

Glitches in the power supply can also affect the power-on reset performance of this device. The glitch width (t_{GW}) and height (t_{GH}) are dependent on each other. The bypass capacitance, source impedance, and device impedance are factors that affect power-on reset performance. [Figure 9](#) provides more information on how to measure these specifications.



Figure 9. Glitch Width and Glitch Height

V_{POR} is critical to the power-on reset. V_{POR} is the voltage level at which the reset condition is released and all the registers and the I2C/SMBus state machine are initialized to their default states. The value of V_{POR} differs based on the V_{CC} being lowered to or from 0. [Figure 10](#) provides more details on this specification.

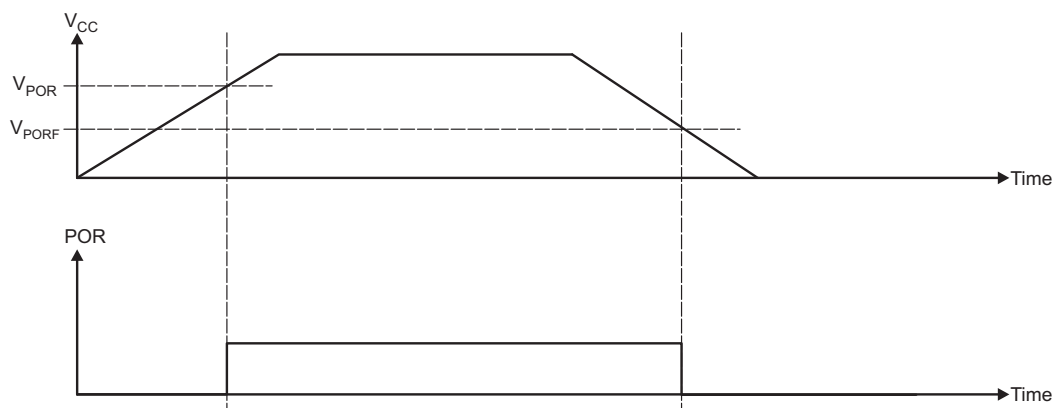


Figure 10. V_{POR}

The table below specifies the performance of the power-on reset feature for TCA8424 for both types of power-on reset.

RECOMMENDED SUPPLY SEQUENCING AND RAMP RATES AT $T_A = 25^{\circ}\text{C}^{(1)}$

over operating free-air temperature range (unless otherwise noted)

| PARAMETER | | MIN | TYP | MAX | UNIT |
|-----------------|--|------|-----|------|---------------|
| t_{FT} | Fall rate | 1 | | 100 | ms |
| t_{RT} | Rise rate | 0.1 | | 100 | ms |
| t_{RR_GND} | Time to re-ramp (when V_{CC} drops to GND) | 40 | | | μs |
| t_{RR_POR50} | Time to re-ramp (when V_{CC} drops to $V_{POR_MIN} - 50\text{ mV}$) | 40 | | | μs |
| V_{CC_GH} | Level that V_{CCP} can glitch down to, but not cause a functional disruption when $V_{CCX_GW} = 1\text{ }\mu\text{s}$ | | | 1.2 | V |
| t_{GW} | Glitch width that will not cause a functional disruption when $V_{CCX_GH} = 0.5 \times V_{CCx}$ | | | 10 | μs |
| V_{PORF} | Voltage trip point of POR on falling V_{CC} | 0.86 | | 1.22 | V |
| V_{PORR} | Voltage trip point of POR on rising V_{CC} | 1.1 | | 1.34 | V |

(1) Not tested. Specified by design

ABSOLUTE MAXIMUM RATINGS⁽¹⁾⁽²⁾

over operating free-air temperature range (unless otherwise noted)

| | | | | MIN | MAX | UNIT |
|-------------|---------------------------------|-------------------------|-----------------------------|------|----------|--------------------|
| V_{CCI} | Supply voltage range | | | -0.3 | 4 | V |
| V_I | Input voltage range | | | -0.3 | 4 | V |
| V_{ILED} | Input voltage range LED outputs | | | -0.3 | 5.5 | V |
| V_{ITEST} | Input voltage range test pin | | | | 7.7 | V |
| I_{IK} | Input clamp current | SCL | $V_I < 0$ | | ± 10 | mA |
| I_{OK} | Output clamp current | INT | $V_O < 0$ | | ± 10 | mA |
| I_{IOK} | Input/output clamp current | SDA | $V_O < 0$ or $V_O > V_{CC}$ | | ± 10 | mA |
| I_{OL} | Continuous output low current | SDA | $V_O = 0$ | | ± 30 | mA |
| | | $\overline{\text{INT}}$ | $V_O = 0$ | | ± 10 | mA |
| | | LEDx | $V_O = 0$ | | ± 20 | mA |
| T_{stg} | Storage temperature range | | | -65 | 150 | $^{\circ}\text{C}$ |

- (1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|-------------------|--------------------------------|---|------------------------|------------------------|------|
| V _{CCI} | Supply voltage | | 1.65 | 3.6 | V |
| V _{test} | Voltage on test pin | During normal operation (in application) | GND | GND | V |
| V _{ILED} | Voltage on LED output | | | 5 | V |
| V _{IH} | High-level input voltage | SCL, SDA | 0.7 × V _{CCI} | 3.6 | V |
| V _{IL} | Low-level input voltage | SCL, SDA | −0.3 | 0.3 × V _{CCI} | V |
| I _{OL} | Low-level output current | SDA | | 20 | mA |
| | | $\overline{\text{INT}}$ | | 3 | mA |
| | | LEDx | | 12 | mA |
| T _A | Operating free-air temperature | | −40 | 85 | °C |

ELECTRICAL CHARACTERISTICS

All values are specified at 25°C operating temperature (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | V _{CC} | MIN | TYP | MAX | UNIT |
|----------------------|---|---|-----------------|------|------|-----|------|
| V _{IK} | Input diode clamp voltage | I _I = −18 mA | 1.65 V to 3.6 V | −1.2 | | | V |
| V _{OL} | ROWx, $\overline{\text{INT}}$ | I _{OL} = 3 mA | 1.65 V | | | 0.4 | V |
| | | | 1.8 V | | | 0.4 | |
| | | | 2.5 V | | | 0.4 | |
| | | | 3.3 V | | | 0.4 | |
| | | | 3.6 V | | | 0.4 | |
| | SDA | I _{OL} = 20 mA | 1.65 V | | | 0.4 | V |
| | | | 1.8 V | | | 0.4 | |
| | | | 2.5 V | | | 0.4 | |
| | | | 3.3 V | | | 0.4 | |
| | | | 3.6 V | | | 0.4 | |
| V _{OL} | LEDx | I _{OL} = 12 mA | 1.8 V | | | 0.4 | V |
| | | | 3.3 V | | | 0.4 | |
| | | | 5 V | | | 0.4 | |
| I _{OL} | LEDx | V _{OL} = 0.4 V | 1.65 V – 5.5 V | 12 | | | mA |
| R _{int} | Internal pull up resistance | | | 80 | 100 | 120 | kΩ |
| I _{ccsh0} | Current consumption | F _{scl} = 0 kHz, oscillator off | 1.65 V | | 0.25 | 8 | μA |
| | | | 1.8 V | | 0.27 | 8 | |
| | | | 2.5 V | | 0.4 | 12 | |
| | | | 3.3 V | | 0.54 | 16 | |
| | | | 3.6 V | | 0.6 | 20 | |
| I _{cc4khz1} | Current consumption | F _{scl} = 400 kHz, oscillator on | 1.65 V | | 17 | 18 | μA |
| | | | 1.8 V | | 18 | 20 | |
| | | | 2.5 V | | 25 | 30 | |
| | | | 3.3 V | | 33 | 40 | |
| | | | 3.6 V | | 39 | 50 | |
| I _{cc1Mhz1} | Current consumption | F _{scl} = 1 MHz, oscillator on | 1.65 V | | 36 | 40 | μA |
| | | | 1.8 V | | 39 | 50 | |
| | | | 2.5 V | | 48 | 60 | |
| | | | 3.3 V | | 65 | 70 | |
| | | | 3.6 V | | 60 | 80 | |
| ΔI _{cc} | Incremental current for duration of key press | One key pressed | 1.65 V – 3.6 V | | 39 | 45 | μA |
| C _{in} | SCL, SDA | | | | 5 | 10 | pF |

I²C INTERFACE TIMING REQUIREMENTS

over operating free-air temperature range (unless otherwise noted)

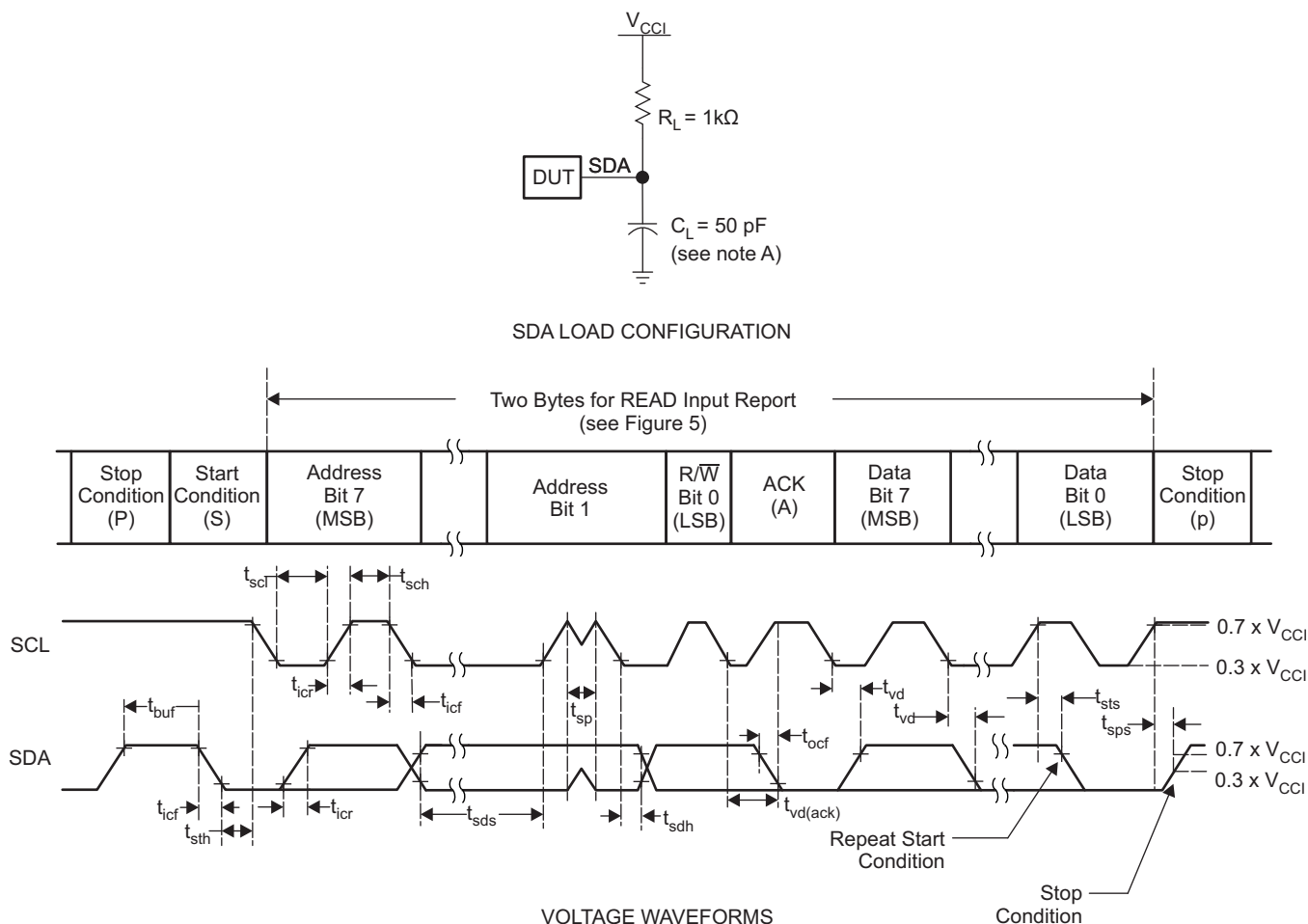
| PARAMETER | STANDARD MODE I ² C BUS | | FAST MODE I ² C BUS | | FAST MODE PLUS (FM+) I ² C BUS | | UNIT |
|---|---------------------------------------|------|-----------------------------------|-----|--|------|------|
| | MIN | MAX | MIN | MAX | MIN | MAX | |
| f _{scl} I ² C clock frequency | 0 | 100 | 0 | 400 | 0 | 1000 | kHz |
| t _{sch} I ² C clock high time | 4 | | 0.6 | | 0.26 | | μs |
| t _{scl} I ² C clock low time | 4.7 | | 1.3 | | 0.5 | | μs |
| t _{sp} I ² C spike time | | 50 | | 50 | | 50 | ns |
| t _{sds} I ² C serial data setup time | 250 | | 100 | | 50 | | ns |
| t _{sdh} I ² C serial data hold time | 0 | | 0 | | 0 | | ns |
| t _{icr} I ² C input rise time | | 1000 | 20 | 300 | | 120 | ns |
| t _{icf} I ² C input fall time | | 300 | 20 x (V _{DD} /5.5 V) | 300 | 20 x (V _{DD} /5.5 V) | 120 | ns |
| t _{ocf} I ² C output fall time; 10 pF to 400 pF bus | | 300 | 20 x (V _{DD} /5.5 V) | 300 | 20 x (V _{DD} /5.5 V) | 120 | μs |
| t _{buf} I ² C bus free time between Stop and Start | 4.7 | | 1.3 | | 0.5 | | μs |
| t _{sts} I ² C Start or repeater Start condition setup time | 4.7 | | 0.6 | | 0.26 | | μs |
| t _{sth} I ² C Start or repeater Start condition hold time | 4 | | 0.6 | | 0.26 | | μs |
| t _{sps} I ² C Stop condition setup time | 4 | | 0.6 | | 0.26 | | μs |
| t _{vd(data)} Valid data time; SCL low to SDA output valid | | 3.45 | 0.3 | 0.9 | | 0.45 | μs |
| t _{vd(ack)} Valid data time of ACK condition; ACK signal from SCL low to SDA (out) low | | 3.45 | 0.3 | 0.9 | | 0.45 | μs |

SWITCHING CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

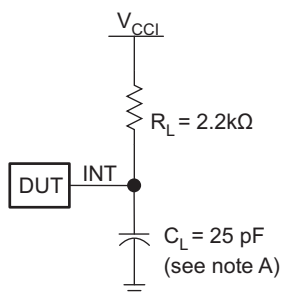
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | MIN | MAX | UNIT |
|--|--------------|-------------|-----|-----|------|
| t _{ir} Interrupt reset delay time | SCL | INT | | 600 | ns |
| t _{pv} Output data valid | SCL | LEDx | | 155 | ns |

PARAMETER MEASUREMENT INFORMATION



- A. C_L includes probe and jig capacitance. t_{ocf} is measured with C_L of 10 pF or 400 pF. All inputs are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_O = 50 \Omega$, $t_r/t_f \leq 30$ ns. All parameters and waveforms are not applicable to all devices.

Figure 11. I²C Interface Load Circuit and Voltage Waveforms



- A. C_L includes probe and jig capacitance. All inputs are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_O = 50 \Omega$, $t_r/t_f \leq 30$ ns. All parameters and waveforms are not applicable to all devices.

Figure 12. Interrupt Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION (continued)

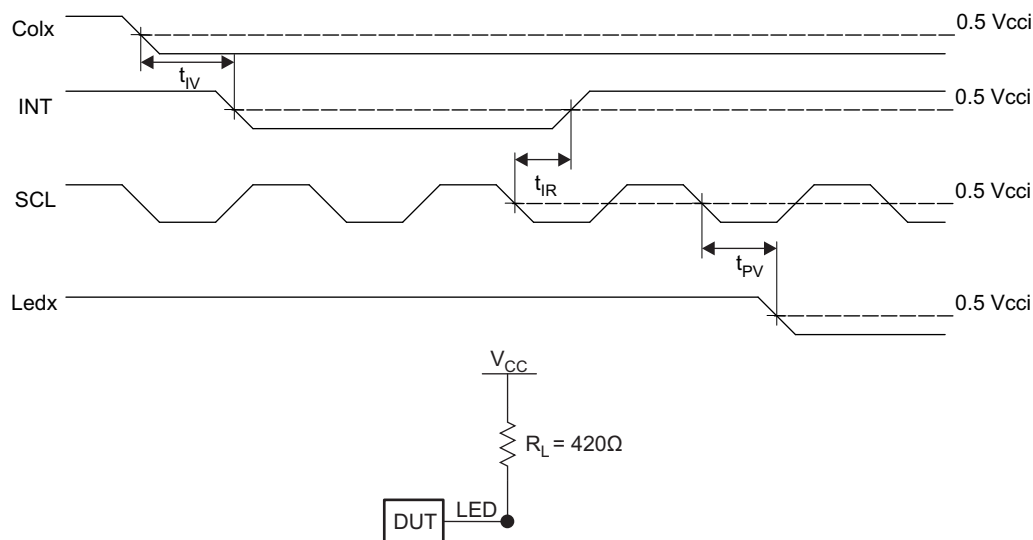


Figure 13. LED Load Configuration

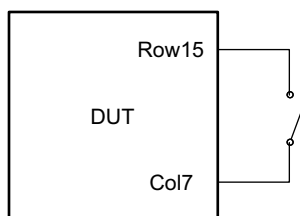


Figure 14. Row Pull-down Load Configuration

C_L includes probe and jig capacitance. t_{PV} is measured from $0.7 \times V_{CC}$ on SCL to 50% I/O (Pn) output. All inputs are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_O = 50\ \Omega$, $t_r/t_f \leq 30$ ns. The outputs are measured one at a time, with one transition per measurement. All parameters and waveforms are not applicable to all devices.

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| TCA8424RHAR | NRND | Production | VQFN (RHA) 40 | 2500 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 85 | PZ 424 |
| TCA8424RHAR.A | NRND | Production | VQFN (RHA) 40 | 2500 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 85 | PZ 424 |

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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GENERIC PACKAGE VIEW

RHA 40

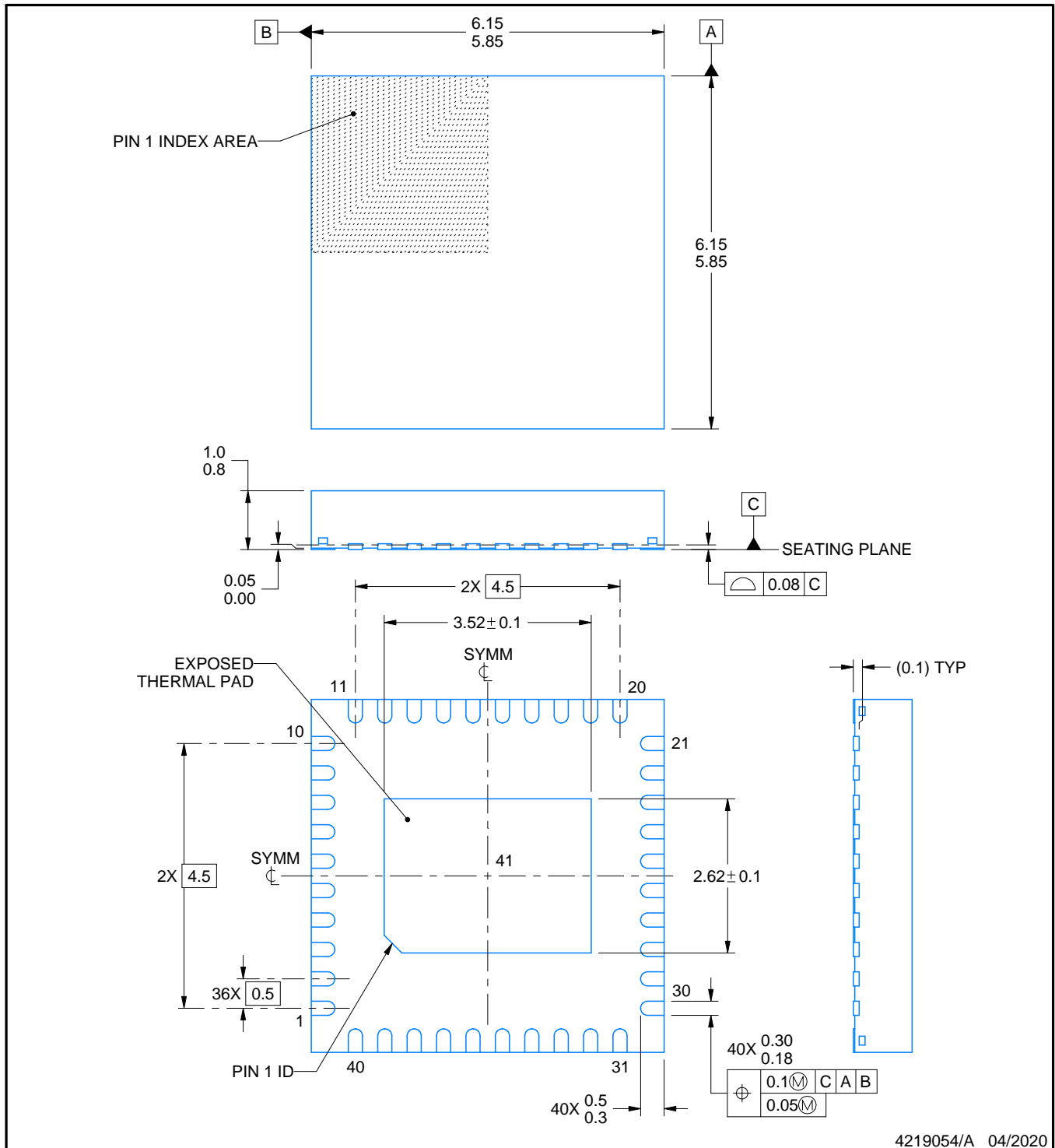
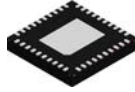
VQFN - 1 mm max height

6 x 6, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.





NOTES:

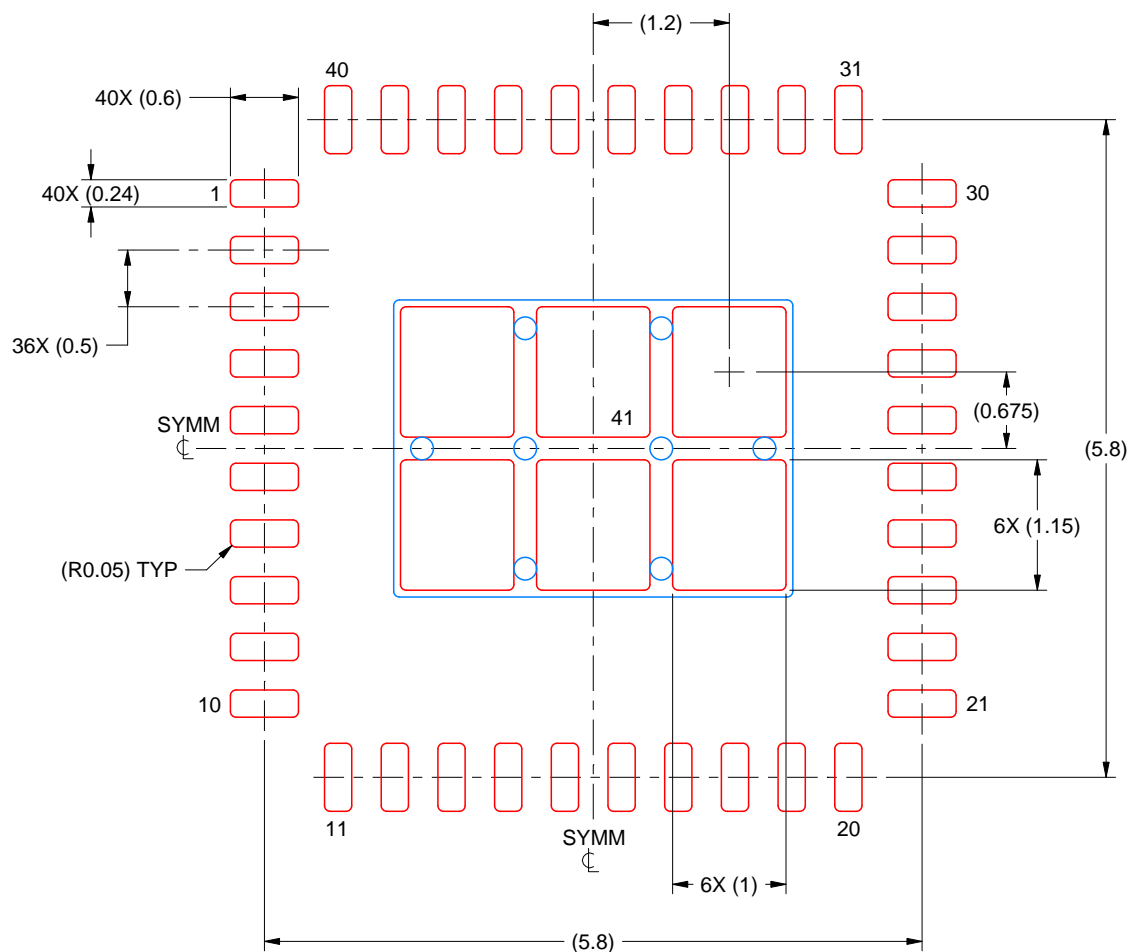
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE STENCIL DESIGN

RHA0040E

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 MM THICK STENCIL
SCALE: 15X

EXPOSED PAD 41
75% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE

4219054/A 04/2020

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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